

## DESCRIPTION

The AM60N10 is available in TO-252 Package.

VDSS	RDSON	ID
100V	16mΩ	60A

### APPLICATIONS

- Power Switching Application
- LED Drive Power
- Power Management for DC/DC

### ORDERING INFORMATION

Package Type	Part Number		
TO-252	D AM60N10DVR	AM60N10DVR	
SPQ: 2,500pcs/Reel	D	AIVIOUNTUDVR	
Note	R: Tape & Reel		
	V: Halogen free Package		
AiT provides all RoHS products			

# ABSOLUTE MAXIMUM RATINGS

T<sub>c</sub> = 25°C, unless otherwise specified.

$I_c = 25^{\circ}C$ , unless otherwise specified.		
V <sub>DSS</sub> , Drain-Source Voltage		100V
V <sub>GSS</sub> , Gate-Source Voltage		±20V
I <sub>D</sub> , Continuous Drain Current		60A
I <sub>DM</sub> , Pulsed Drain Current <sup>(1)</sup>		180A
E <sub>AS</sub> , Single Pulse Avalanche Energy <sup>(2)</sup>		200mJ
P <sub>D</sub> , Maximum Power Dissipation	Tc = 25°C	134W
T <sub>STG</sub> , Storage Temperature Range	-55°C ~ +150°C	
T <sub>J</sub> , Operating Junction Temperature Range		-55℃ ~ +150℃
TL, Maximum Lead Temperature for Soldering Purposes,		260°C
1/8" from Case for 5 Seconds		260 C
Rth(ch-c), Thermal Resistance, Junction to Case		0.93°C/W

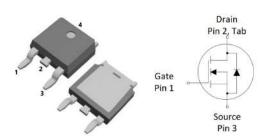
Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) Repetitive Rating: pulse width limited by maximum junction temperature.

(2) L=0.5mH, Rg=25 $\Omega$ , starting T<sub>J</sub>=25°C

- 60A,100V, R<sub>DS(ON)MAX</sub>=16mΩ@V<sub>GS</sub>=10V/20A
- Low Gate Charge
- Low C<sub>iss</sub>
- Fast switching
- Improved dv/dt Capability

### PIN DESCRIPTION



TO-252

Pin #	Symbol	Function
1	G	Gate
2,4	D	Drain
3	S	Source



# **ELECTRICAL CHARACTERISTICS**

 $T_C$  = 25°C, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Off Characteristics		•				
Drain-Source Breakdown Voltage	Bvdss	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	100	-	-	V
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			1	μA
Gate-Body Leakage Current, Forward	I <sub>GSSF</sub>	$V_{GS}$ =20V, $V_{DS}$ =0V			100	nA
Gate-Body Leakage Current, Reverse	Igssr	V <sub>GS</sub> = -20V, V <sub>DS</sub> =0V			-100	nA
On Characteristics						
Gate-Source Threshold Voltage	V <sub>GS(TH)</sub>	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	2	-	4	V
Drain-Source On-State Resistance	RDS(ON)	$V_{GS}$ =10V, $I_{D}$ = 20A	-	14	16	mΩ
Dynamic Characteristics		•				
Input Capacitance	Ciss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,	-	3720	-	pF
Output Capacitance	Coss		-	225	-	
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	183	-	
Switching Characteristics						
Turn-On Delay Time	t <sub>d(on)</sub>		-	12	-	ns
Turn-On Rise Time	tr	$V_{DD}$ =50V, $R_G$ =3 $\Omega$ ,	-	9	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =10V	-	20	-	
Turn-Off Fall Time	t <sub>f</sub>		-	18	-	
Total Gate Charge	Qg	(1 - 20)(1 - 20)(1	-	80	-	
Gate-Source Charge	Qgs	$V_{DS} = 80V$ , $I_{D} = 30V$	-	23	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	26	-	
Reverse Diode						
Diode Forward Voltage	Vsd	Is=20A, V <sub>GS</sub> =0V	-	-	1.2	V

\* Pulse text: Pulse width  $\leq$  300µs, Duty Cycle  $\leq$  2%.



## TYPICAL PERFORMANCE CHARACTERISTICS

Fig 1. Typical Output Characteristics

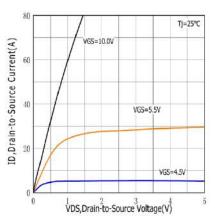
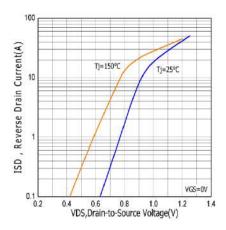
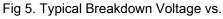
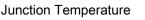


Fig 3. Typical Body Diode Transfer Characteristics







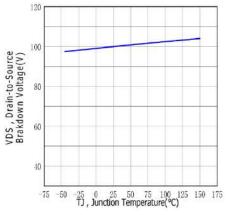


Fig 2. Typical Gate Charge vs. Gate to Source Voltage

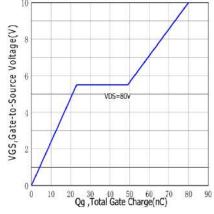


Fig 4. Typical Capacitance vs. Drain to Source Voltage

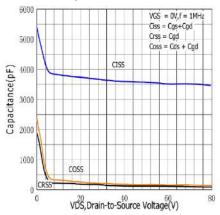
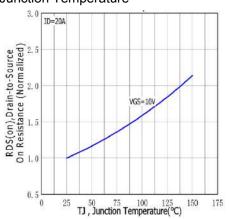


Fig 6. Typical Drain to Source on Resistance vs. Junction Temperature





#### Fig 7. Maximum Forward Bias Safe Operating Area

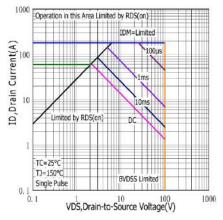


Fig 9. Maximum EAS vs. Channel Temperature

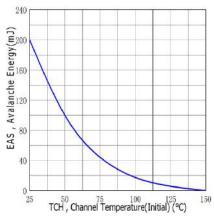


Fig 11. Typical Transfer Characteristics

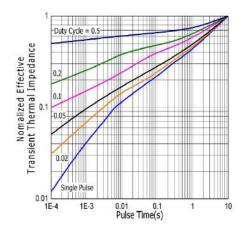


Fig 8. Typical Drain to Source ON Resistance

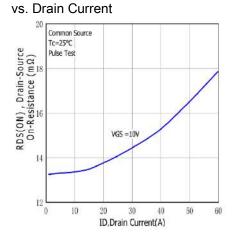


Fig 10. Typical Threshold Voltage vs.

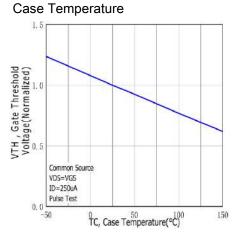


Fig 12. Maximum Power Dissipation vs.

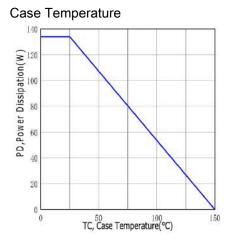
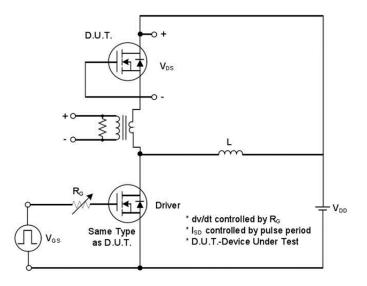
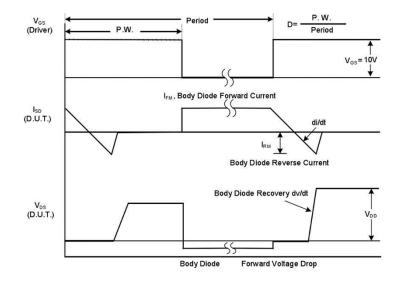




Fig 13. Peak Diode Recovery dv/dt Test Circuit



#### Fig 14. Peak Diode Recovery dv/dt Waveforms





#### Fig 15. Switching Test Circuit

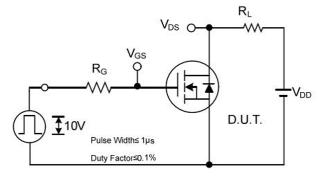


Fig 16. Switching Waveforms

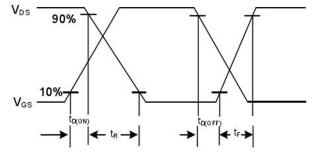


Fig 17. Gate Charge Test Circuit

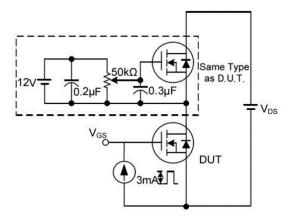


Fig 19. Unclamped Inductive Switching Test Circuit

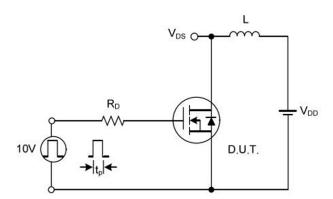
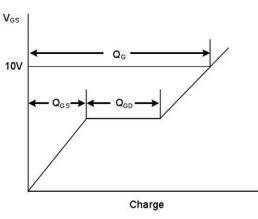
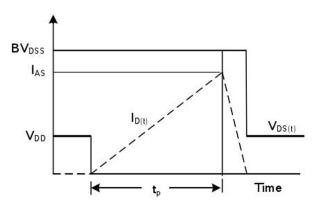


Fig 18. Gate Charge Waveform



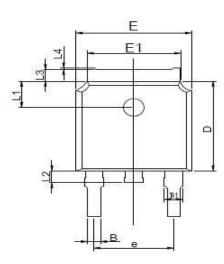


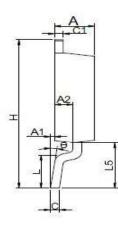


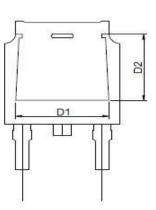


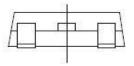
# PACKAGE INFORMATION

Dimension in TO-252 (Unit: mm)

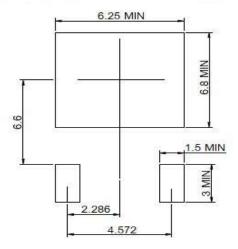








#### RECOMMENDED LAND PATTERN



Complexel.	Millimeter			
Symbol	Min.	Max.		
A	2.150	2.450		
A1	0.050	0.200		
A2	0.910	1.220		
В	0.660	0.860		
B1	0.930	1.230		
С	0.400	0.600		
C1	0.400	0.600		
D	5.950	6.250		
D1	4.800			
D2	3.800			
E	6.450	6.750		
E1	5.120	5.520		
L	1.650			
L1	1.580	1.980		
L2	0.600	1.000		
L3	0.700	1.000		
L4	0.000	0.200		
L5	2.800	3.400		
Н	9.800	10.400		
θ	0°	8°		
е	4.572 REF			



### IMPORTANT NOTICE

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